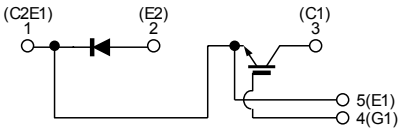
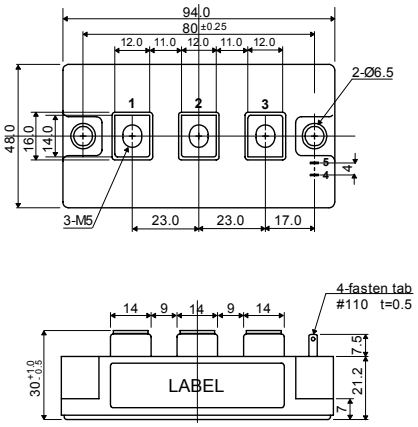
ＩＧＢＴ Module-Chopper　　２００A, 600V　　ＰＣＨＭＢ２００Ｅ６

□ 回路図 : *CIRCUIT*



□ 外形寸法図 : *OUTLINE DRAWING*



Dimension: [mm]

□ 最大定格 : *MAXIMUM RATINGS* (T_C=２５℃)

Item		Symbol	Rated Value	Unit
コレクタ・エミッタ間電圧 Collector-Emitter Voltage		V_{CES}	６００	V
ゲート・エミッタ間電圧 Gate-Emitter Voltage		V_{GES}	±２０	V
コレクタ電流 Collector Current	DC	I_C	２００	A
	1ms	I_{CP}	４００	
コレクタ損失 Collector Power Dissipation		P_C	７８０	W
接合温度 Junction Temperature Range		T_j	－４０～＋１５０	℃
保存温度 Storage Temperature Range		T_{stg}	－４０～＋１２５	℃
絶縁耐圧(Terminal to Base AC, 1minute) Isolation Voltage		V_{ISO}	2,５００	$V_{(RMS)}$
締め付けトルク Mounting Torque	Module Base to Heatsink	F_{tor}	3 (30.6)	N・m (kgf・cm)
	Busbar to Main Terminal		2 (20.4)	

□ 電気的特性 : *ELECTRICAL CHARACTERISTICS* (T_C=２５℃)

Characteristic		Symbol	Test Condition	Min.	Typ.	Max.	Unit
コレクタ遮断電流 Collector-Emitter Cut-Off Current		I_{CES}	V_{CE}= 600V, V_{GE}= 0V	－	－	1.0	mA
ゲート漏れ電流 Gate-Emitter Leakage Current		I_{GES}	V_{GE}= ±20V, V_{CE}= 0V	－	－	1.0	μA
コレクタ・エミッタ間飽和電圧 Collector-Emitter Saturation Voltage		$V_{CE(sat)}$	I_C= 200A, V_{GE}= 15V	－	2.1	2.6	V
ゲートしきい値電圧 Gate-Emitter Threshold Voltage		$V_{GE(th)}$	V_{CE}= 5V, I_C= 200mA	4.0	－	8.0	V
入力容量 Input Capacitance		C_{ies}	V_{CE}= 10V, V_{GE}= 0V, f= 1MHz	－	10,000	－	pF
スイッチング時間 Switching Time	上昇時間 Rise Time	t_r	V_{CC}= 300V R_L= 1.5Ω R_G= 3.6Ω V_{GE}= ±15V	－	0.15	0.30	μs
	ターンオン時間 Turn-on Time	t_{on}		－	0.25	0.40	
	下降時間 Fall Time	t_f		－	0.10	0.35	
	ターンオフ時間 Turn-off Time	t_{off}		－	0.35	0.70	

□フリーホイーリングダイオードの特性: *FREE WHEELING DIODE RATINGS & CHARACTERISTICS* (T_C=２５℃)

Item		Symbol	Rated Value	Unit
順電流 Forward Current	DC	I_F	２００	A
	1ms	I_{FM}	４００	

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
順電圧 Peak Forward Voltage	V_F	I_F= 200A, V_{GE}= 0V	－	1.9	2.4	V
逆回復時間 Reverse Recovery Time	t_{rr}	I_F= 200A, V_{GE}= -10V di/dt= 400A/μs	－	0.15	0.25	μs

□ 熱的特性 : *THERMAL CHARACTERISTICS*

Characteristic		Symbol	Test Condition	Min.	Typ.	Max.	Unit
熱抵抗 Thermal Impedance	IGBT	Rth(j-c)	Junction to Case (Tc測定点チップ直下)	－	－	0.16	℃／W
	Diode			－	－	0.38	

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Fig.1- Output Characteristics (Typical)

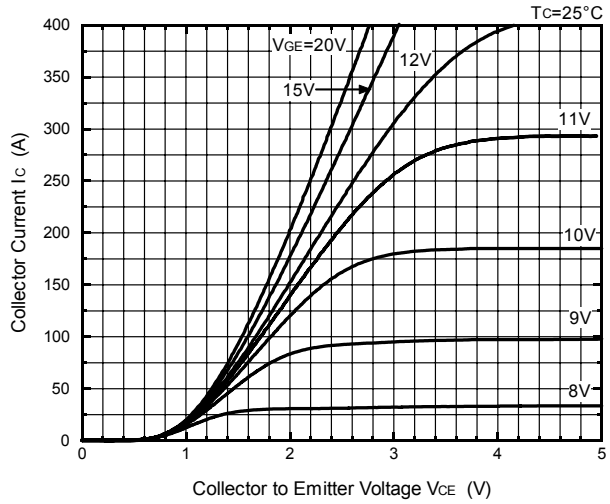


Fig.2- Output Characteristics (Typical)

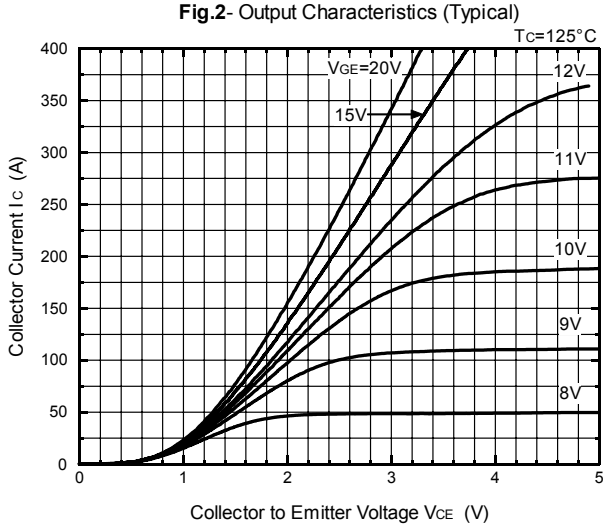


Fig.3- Collector to Emitter On Voltage vs. Gate to Emitter Voltage (Typical)

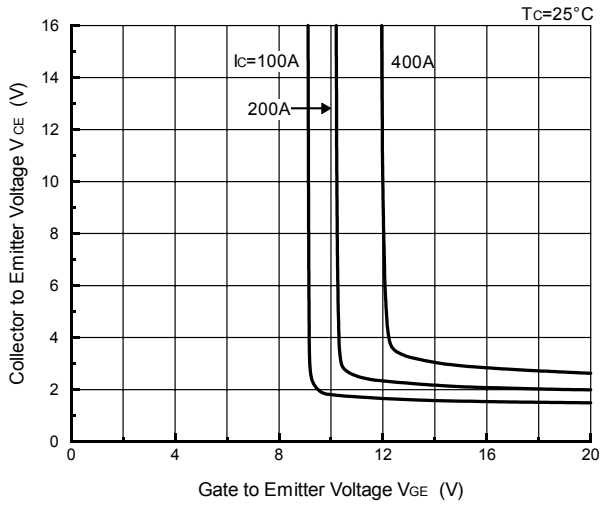


Fig.4- Collector to Emitter On Voltage vs. Gate to Emitter Voltage (Typical)

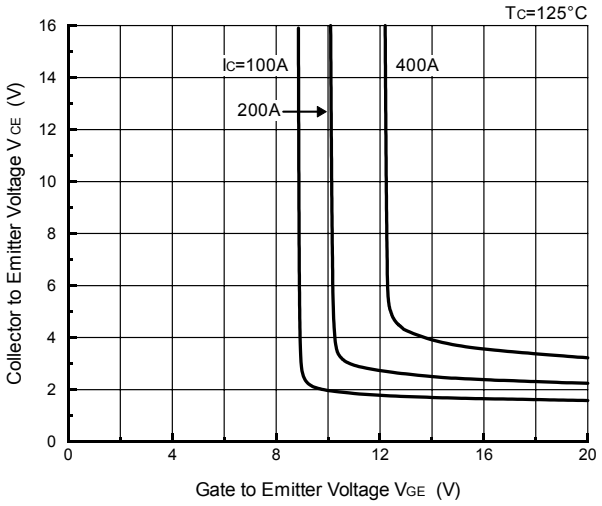


Fig.5- Gate Charge vs. Collector to Emitter Voltage (Typical)

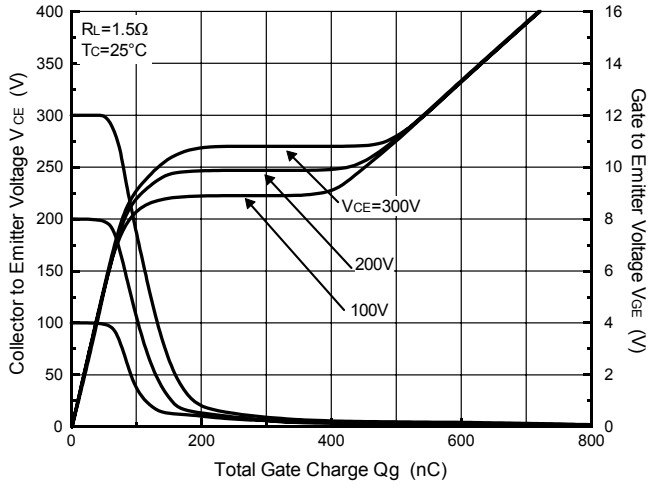


Fig.6- Capacitance vs. Collector to Emitter Voltage (Typical)

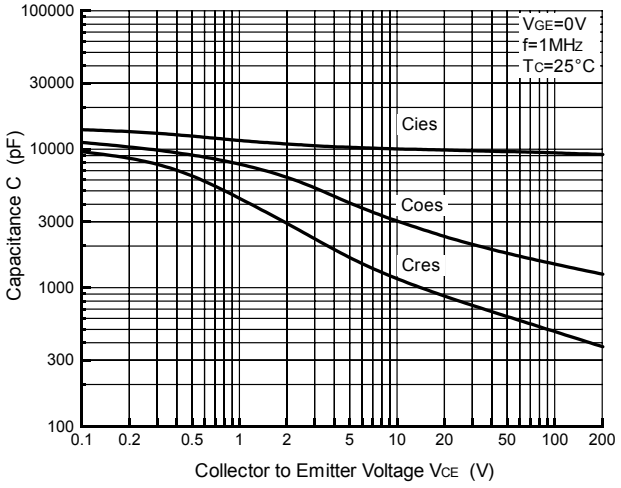


Fig.7- Collector Current vs. Switching Time (Typical)

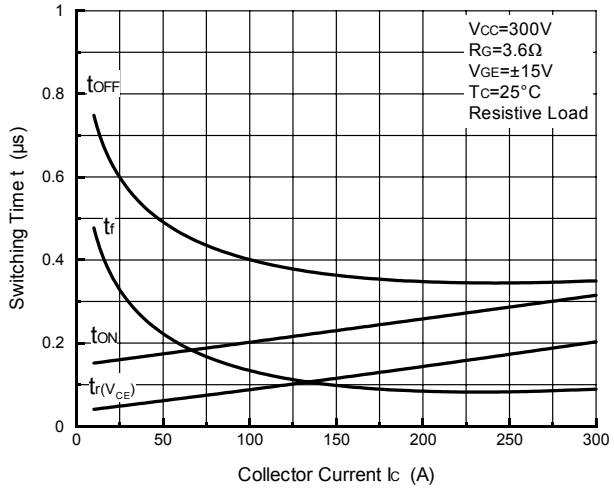


Fig.8- Series Gate Impedance vs. Switching Time (Typical)

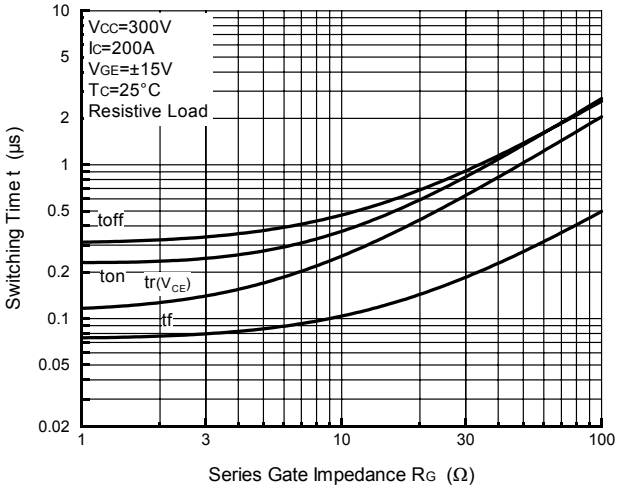


Fig.9- Collector Current vs. Switching Time

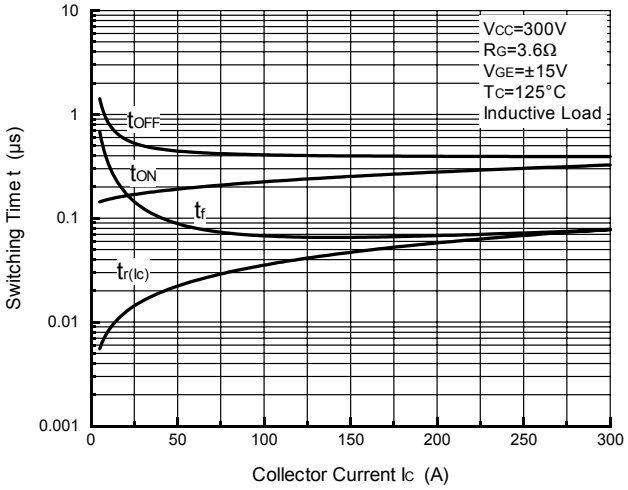


Fig.10- Series Gate Impedance vs. Switching Time

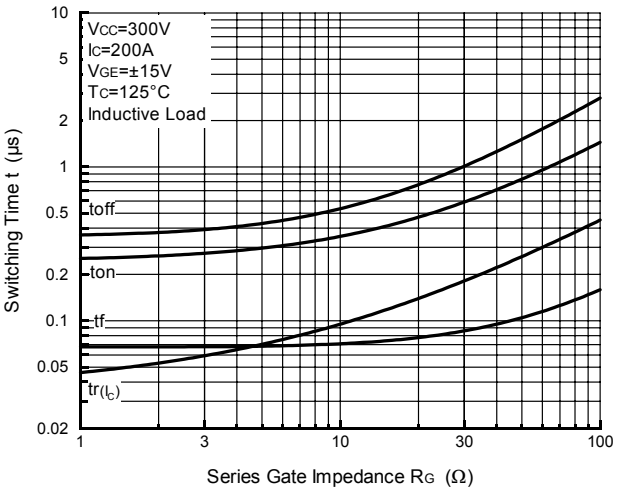


Fig.11- Collector Current vs. Switching Loss

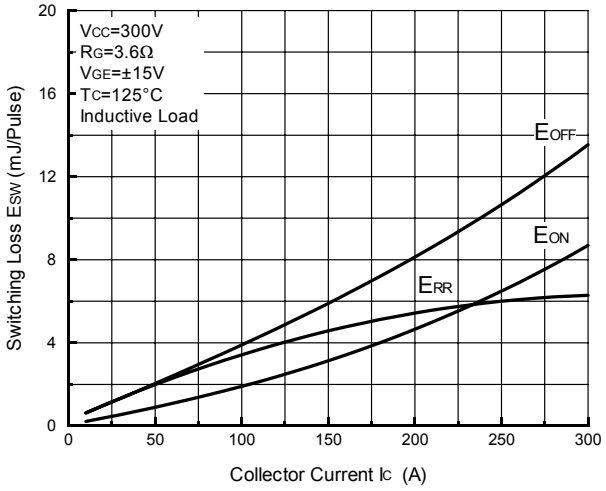


Fig.12- Series Gate Impedance vs. Switching Loss

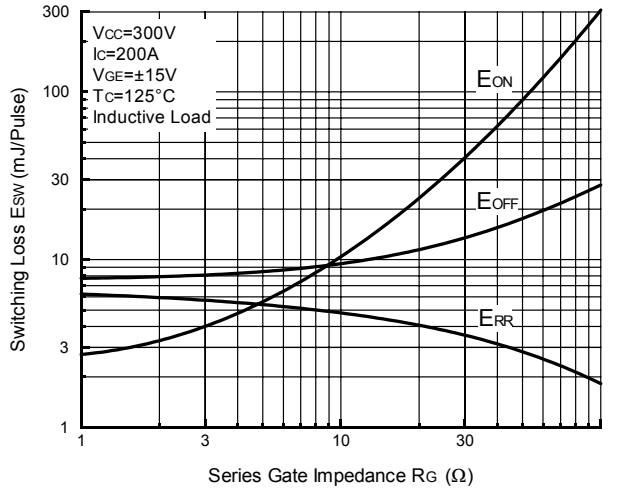


Fig.13- Forward Characteristics of Free Wheeling Diode (Typical)

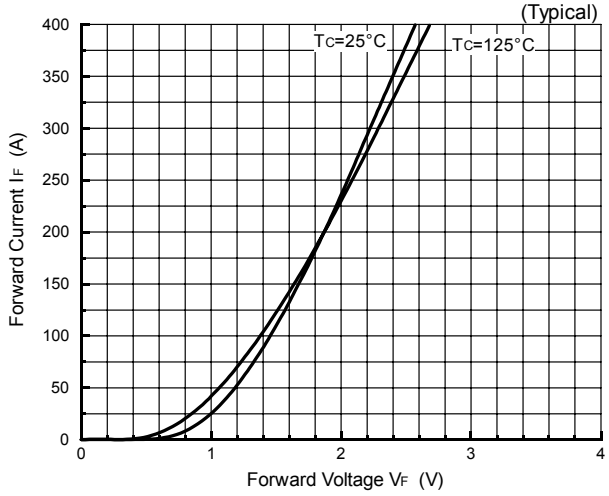


Fig.14- Reverse Recovery Characteristics (Typical)

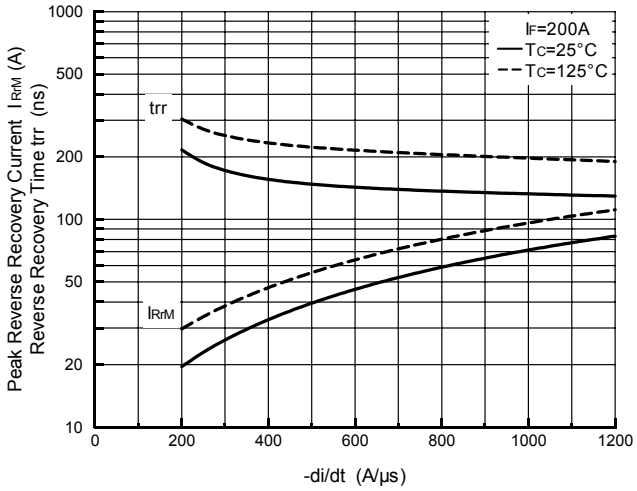


Fig.15- Reverse Bias Safe Operating Area

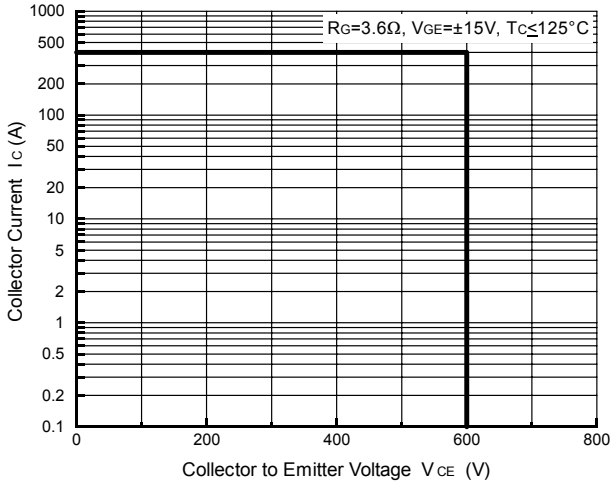


Fig.16- Transient Thermal Impedance

